

NEWS ALERT

Cortec® Goes Green as Pack Expo Turns 50!



November 8, 2006

Cortec's Innovative Corrosion Inhibiting & Biodegradable Technologies were a huge hit at Pack Expo 2006 that took place at the McCormick Center in Chicago, Illinois (Oct. 29 - Nov. 2). Cortec® Specialists from around the world joined together to welcome Pack Expo attendees.

Pack Expo is the largest packaging trade show in North America and has long been the strategic launching pad for new products developed by Cortec® Corporation. With increasing interest in sustainable packaging within the last several years, Cortec® enjoyed its busiest booth ever at Pack Expo!

This year, Cortec® introduced several new packaging technologies, including:

- Eco-Corr® Compostable/Biodegradable VpCI™ Film and Bags
- Eco-Corr® ESD Compostable/Biodegradable VpCI™

Static Protective Film and Bags

- CorPak® Linerboard for Corrugate Box Manufacturing
- Desicorr™ and Desicorr VpCI™ desiccating & corrosion inhibiting packets with indicator
- VpCI™-145 ESD Corrosion Inhibiting, Static Protective Paper
- Corrosorber™ Paper for tarnish protection of silver and H₂S susceptible components
- EcoWorks® 70 Biobased, Certified Compostable Film and Bags

Cortec's very own Bill Harrod (regional sales manager) and his Chicago-based band, "The Bottoms Up" performed during Cortec's Customer Appreciation Dinner at the Chicago Hilton on Sunday October 29. The event celebrated Cortec's exceptional growth over the past two years.